

**PATENT APPLICATION**

Attorney Docket: 54486-D1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Patti
Serial No.: 10/658,132
Filed: 9/8/2003
For: Interlocking Conductor Method for
Bonding Wafers to Produce Stacked
Integrated Circuits
Group Art Unit: 2823

Examiner: Toledo, Fernando

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL OF AMENDMENT UNDER RULE 312

In response to the Notice of Allowance dated 6/2/2004, Applicants submit herewith an Amendment under Rule 312 in the above identified patent application.

Applicants believe that no fee is required for this amendment. However, the Commissioner is hereby authorized to charge any fees which may be required in this application under 37 C.F.R. Section 1.16-1.17 during its entire pendency, or credit any overpayment, to Deposit Account No. 23-0424.

This sheet is filed in duplicate via fax number: 703-~~872-9306~~ 746-4000

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8/30/04

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AMENDMENT UNDER RULE 312

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Mail Stop:
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Sir:

Under the provisions of Rule 312 of the Patent and Trademark Office (37 CFR 1.312), it is respectfully requested that the above-identified application be amended as follows: